## ONSTATIC TECHNOLOGY CO., LTD.

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## PHOTOIMAGEABLE SOLDER MASK

# R-500 MK / HD-5

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#### 1. FEATURES

- (1) For screen printing.
- (2) Excellent in adhesion.
- (3) Suitable to general printed circuit boards.

#### 2. SPECIFICATION

Main agent **R-500 MK** Hardener HD – 5 Color Black **Mixing ratio** Main agent : 750g / Hardener : 250g Viscosity  $190 \pm 30 \text{ ps}$ (main agent) (R type viscometer at 25°C) Solid content 70~75 wt% **Specific gravity**  $1.3 \pm 0.2$ 75°C x 70 min (maximum) Tack- dry window  $700 - 900 \text{ mJ} / \text{cm}^2$  (on the solder) **Exposure energy** \* Pot life 24 hours ( stored at 25°C or below in dark place ) 6 months after manufacturing Shelf life (stored at 25°C or below in dark place)

\*After mixing with hardener.

## 3. PROCESS CONDITIONS

Surface treatment	: Acid treatment $\rightarrow$ Brushing
Coating	: Screen printing with 90 - 120 mesh screen
Hold time	: 10 - 20 min.
Tack dry	<ul> <li>A. One side each exposure <ul> <li>1st side; 70 - 75°C / 15 - 20 min. (Hot air convention oven)</li> <li>2nd side; 70 - 75°C / 20 - 30 min. (Hot air convention oven)</li> </ul> </li> <li>B. Both sides simultaneous exposure <ul> <li>70 - 75°C / 35 - 50 min. (Hot air convention oven)</li> </ul> </li> </ul>
Exposure	$: 700 - 900 \text{ mJ} / \text{cm}^2$ (on the solder)
Hold time	: 10 - 30 min.
Development	: Developer ; $1wt\%$ Na <sub>2</sub> CO <sub>3</sub> Temperature ; $29 - 31^{\circ}C$ Spray pressure ; $2.5 - 3.0 \text{ kg / cm}^2$ Dwell time ; $70 - 100 \text{ sec.}$
Water rinse	: Temp. 30°C or below Spray pressure ; 1 - 1.5 kg / cm <sup>2</sup> Dwell time ; 45 - 60 sec.
Post cure	: Non plugging ; 150 - 160 °C / 60 min. ( Hot air convention oven )
	Plugging ;
	80°C x 30min→110°C x 30 分→160°C x 60min (Hot air convention oven)

## 4. CHARACTERISTIC

#### (1). TACK DRY WINDOW

Tack dry window (min. @75°C)	40	50	60	70	80	90
Developability	0	0	0	0	OΔ	$\times$

#### (2). HOLD TIME

Hold time (hrs)	24	36	48	72
Developability	0	0	0	$\times$
(Holding at 20°C / 60%RH after drying at 75°C / 25 mins.)				

#### (3).PHOTOSENSITIVITY

Item	Thickness	Energy	Dwell time	Sensitivity
Sensitivity		700 mJ/cm <sup>2</sup>		9 - 11wedges
Stouffer	$25~\mu$ m	800 mJ/cm <sup>2</sup>	60sec	10 - 12wedges
(21steps tablet)		900 mJ/cm <sup>2</sup>		11 - 13wedges
Exposure energy is me	easured at under Myla	ar film.		

### 5. PROPERTIES

Item	Test method	Result	
A dia asian	Cross Cut Adhesion Tester	100/100	
Adhesion	(Simex Cat No.01-903-01)	100/100	
Donail handnoog	Pencil Hardness Tester	> <i>4</i> 11	
Pencil hardness	(Yasuda/NO.553-M)	≧6H	
Solder heat resistance	Rosin flux 260°C / 30sec, 1cyles	Pass	
Solvent resistance	PGM-Ac, room temp./30min	Dese	
Solvent resistance	Cross hatch peeling	Pass	
Acid resistance	10vo1% H <sub>2</sub> SO <sub>4</sub> , room temp./20min	Pass	
Acid resistance	Cross hatch peeling	F 855	
Alkaline resistance	10wt% NaOH, room temp./20min	Pass	
Aikainie resistance	Cross hatch peeling	1 855	
Electroless gold plate	NI; 125 $\mu$ inch Au; 3 $\mu$ inch	Pass	
$\mathbf{t} \cdot \mathbf{T} \mathbf{h} \mathbf{e}$ above-mentioned test	t data is only for reference not to guarantee the s	ame in vour proce	

Note : The above-mentioned test data is only for reference, not to guarantee the same in your process.

## 6. R-500 MK COMPLY WITH IPC-SM-840C Class H

Property	Test Method	Requirement	Test Result
3.4.8. Visual	Magnifying lens rated between 1.75 to 10X magnification	No cracks No peeling and roughness. Free of foreign materials.	OK
3.5.2.1. Adhesion (tape method)	Determined in accordance with TM2.4.28.1 of IPC-TM-650. Differentiation of class shall be required.	Bare Copper $\leq 0\%$ Gold or Nickel $\leq 5\%$ Base Laminate $\leq 0\%$ Melting Metals $\leq 10\%$ (Tin-Lead plating)	PASSED PASSED PASSED PASSED
3.5.3.	Subjected to drilling, routing,	No cracks, No peeling and	PASSED
Mashinability 3.5.1 Pencil Method	sawing or punching. 45degree angle, forward pressure in a 1/4 inch.	roughness. No softer than "F"	PASSED/6H
3.4.5. Curing	<ul><li>3.6.1.1.Resistance to Solvents and Cleaning Agents.</li><li>3.7.1.Solderability.</li><li>3.7.2.solder resistance.</li></ul>	Must meet requirements of 3.6.1., 3.7.2.and 3.7.3.	PASSED PASSED PASSED
3.6.1. Desistance	• Isopropanol room temperature	No surface roughness,	PASSED
Resistance to solvents, Cleaning	2 minutes. • 75%Isopropanol/25%water 46±2°c a 15 minutes.	olisters, delamination, swelling, and color change.	PASSED
Agents, Flux	room temperature. . D-Limonene room temperature 2 minutes.		PASSED
	<ul> <li>10% Alkaline detergent</li> <li>EXP. ≤40% alkanolamine</li> <li>≤20% 2-butoxyethanol</li> <li>≤20% glycol ether and the remaining 90% water (PH=13 or less)</li> <li>57±2°c 2 minutes.</li> </ul>		PASSED
	. Monoethanolamine 57±2°c 2 minutes		PASSED
	. Deionized water 60±2°c 2 minutes		PASSED
3.6.3. Flammbility	UL-94 flammability.	UL-94 V number shall not be raised.	94 V-0
3.7.1. Solderbility	After flux coated, hold at ambient temperature for 5 minutes, preheat and solder float at $255\pm5^{\circ}$ C for $10\pm1$ seconds.	Solderbility of boads shall not be diminished.	PASSED
3.7.2. Resistance to solder	After flux coated, hold at ambient temperature for 5 minutes, preheat and solder float at $255\pm5^{\circ}$ C for $10\pm1$ seconds.	Solder shall not adhere to the solder mask.	PASSED

3.6.2.	97±2°C 90-98%RH 28 days.	No irreversible change of state.	PASSED
Hydrolytic	-	_	
Stability/Aging			
3.8.1.	Detemined in accordance with	Minimum value of 500 VDC	PASSED
Dielectric	TM2.5.6.1 of IPC-TM-650	per 0.025 mm [0.001 inch] of thickness.	1.9KV/mil
Strength			
3.8.2.	Minimum resistance of show	Minimum $5 \times 10^8 \Omega$ at 500 VDC.	Before Soldering
Insulation	before and after soldering.	IPC-B-25 test pattern B.	$2.30 \times 10^{13} \Omega$
			After Soldering
Resistance			$2.50 \times 10^{12} \Omega$
3.9.1.	25-65°c 85%RH Cycling 6 2/3	Minimum $5 \times 10^8 \Omega$ at 500 VDC.	Initial
Moisture		IPC-B-25 test pattern B.	$1.8 \times 10^{13} \Omega$
	days	IFC-D-23 lest pattern D.	
and	Bias voltage 50 VDC and Test		After Treatment
Insulation	Voltage 100 VDC.		$1.6 \times 10^{12} \Omega$
Resistance			
3.9.2.	85±2°c 90%RH 168 hours.	None allowed . Resistance $\geq$	PASSED
Electromigration	Bias voltage 10VCD and Test	$2M\Omega$	
	Volatage 10VC		
3.9.3.	-65°c 15 min +125°c 15 min,	No blistering, crazing, and	PASSED
Thermal	Transition should not exceed 2	delamination.	
Shock	minutes. 100 cycles.		
OHOCK	minutus. 100 cycles.		

## Note :

All test data mentioned above in this technical data sheet and process conditions are based on our laboratory test result and only for reference, we suggest testing for suitability in your application.

## **MATERIAL SAFETY DATA SHEET**

#### 1. CHEMICAL PRODUCT & COMPANY IDENTIFICATION

Chemical Name: Trade Name:	Photoimageable Solder Mask R-500 MK
Suggestion and Restriction:	Protect PCB surface from scratch and for insulation.
	Fully mixing with hardener. Printing with screen, exposure and development.
Company:	Onstatic Technology Co., Ltd.
	7F., No.1,Ren' ai Rd., Yingge Dist., New Taipei City
	239,Taiwan(R.O.C.)
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#### 2. HAZARDS IDENTIFICATION

GHS Classification

- 1. Flammable Liquids 4
- 2. Skin Corrosion/Irritation 2
- 3. Eye Damage/Irritation 2A
- 4. Toxic to Reproduction 1
- 5. Hazardous to the Aquatic Enviroment Acute Hazard 2

Symbol



Signal word	Warning
<b>Emergency Overview</b>	
HAZARD	1. Flammable Liquids
	2. Causes skin irritation
	3. Causes serious eye irritation
	4. May damage fertility or the unborn child
	5. Toxic to aquatic life
PRECAUTIONARY	Y STATEMENT
Prevention	1. Obtain special instructions before use.
	2. Do not handle until all safety precautions have been read and
	understood.
	3. Wear protective gloves/clothing and eye/face protection
	4. Avoid breathing fume/gas/mist/vapors.
	5. Do not eat, drink or smoke when using this product.
	6. Keep away from heat/sparks/open flame- No smoking.
	7. Use explosion-proof electrical/ventilating/lighting equipment.
	8. Wash hands thoroughly after handling.
	9. Avoid contact during pregnancy/while nursing.

10. Avoid release to the environment

11. Keep container tightly closed when not use.

#### 3. COMPOSITION INFORMATION

CAS No.	CONTENT
	approx. percentage
34590-94-8	10%
88917-22-0	10%
25068-38-6	35%
64742-94-5	5%
71868-10-5	10%
7727-43-7	29%
1333-86-4	1%
	34590-94-8 88917-22-0 25068-38-6 64742-94-5 71868-10-5 7727-43-7

#### 4. FIRST-AID MEASURES

EYE CONTACT:	Immediately flush with plenty of water and continue washing for several minutes. Seek medical advice.
SKIN CONTACT:	Remove all contaminated clothing. Wash skin with soap and plenty
	of water. Obtain medical advice if irritation persists. Wash
	contaminated clothing before reuse.
INGESTION:	Wash out mouth with water. Remove dentures if any. Move
	exposed person to fresh air. Keep person warm and at rest. If
	vomiting occurs, the head should be kept low so that vomit does
	not enter the lungs. Get medical attention immediately.
INHALATION:	Move exposed person to fresh air. Seek medical advice if
	symptoms persist.
Notes to physician	No specific treatment. Treat symptomatically.

#### 5. FIRE FIGHTING MEASURES

FLASH POINT: 78°C METHOD USED: Setaflash closed-cup

- EXTINGUISHING MEDIA: Water spray, carbon dioxide, dry chemical power or appropriate foam.
- SPECIAL FIRE FIGHTING PROCEDURES: Wear self-contained breathing apparatus (SCBA) and protective clothing to prevent contact with skin and eyes.

UNUSUAL FIRE AND EXPLOSIONS HAZARDS: Emits toxic fumes under fire conditions.

# 6. ACCIDENTAL RELEASE MEASURES (See Section 15 for Regulatory Information)

Personal	Avoid breathing vapor. Provide adequate ventilation. Wear appropriate
precautions	respirator when ventilation is inadequate.
Environmental	Avoid dispersal of spilled material and runoff and contact with soil,
precautions	waterways, drains and sewers.
Spill	Stop leak if without risk. Move containers from spill area. Prevent entry
	into sewers, water courses, basements or confined areas. Sweep up
	material and place in a designated, labelled waste container. Dispose of
	via a licensed waste disposal contractor.

#### 7. HANDLING AND STORAGE

HANDLING:	Avoid contact with eye.
	Keep away from heat, flame and sunlight.
	Wash through after handling.
STORAGE:	Stored in dark and cool place.

#### 8. EXPOSURE CONTROLS/PERSONAL PROTECTION

ENGINEERING CONTROLS:	Mechanical exhaust required.	
	Keep tightly closed.	
	Store in a cool dry place.	
PERSONAL PROTECTION:	Chemical safety goggles.	
Hands	Compatible chemical resist gloves.	
Eyes	Wear noish-approved respiration.	
Skin	Safety shower and eye bath.	
	Avoid contact with eyes, skin and clothing.	
	Wash thorough after handling.	
Environmental exposure controls	Emissions from ventilation or work process	
	equipment should be checked to ensure they	
	comply with the requirements of environmental	
	protection legislation. In some cases, fume	
	scrubbers, filters or engineering modifications to	
	the process equipment will be necessary to reduce	
	emissions to acceptable levels.	

## 9. PHYSICAL AND CHEMICAL PROPERTY

APPEARANCE: ODOR:	Black paste Ether odor
pH (as supplied):	Not Applicable
VAPOR PRESSURE:	2mm Hg @ 38°C
VAPOR DENSITY:	4.7
MELTING POINT:	<-20°C
BOILING POINT:	>190°C
FLASH POINT:	78°C
AUTOIGNITION POINT:	>360°C
DECOMPOSITION POINT:	Not Applicable
WATER SOLUBILITY:	immiscible
SPECIFIC GRAVITY:	1.3±0.2/25°C
EVAPORATION RATE:	Not Applicable

#### **10. CHEMICAL STABILITY AND REACTIVITY INFORMATION**

CHEMICAL STABILITY: Stable under recommended storage conditions. See storage section.

INCOMPATIBILITY (Materials to Avoid): Strong acids, strong bases, peroxides and strong oxidizing agents.

#### 11. TOXICOLOGICAL INFORMATION

ACUTE EFFECTS:Causes eye and skin irritation.INGREDIENT NAME:Dipropylene glycol monomethyl ether acetate (DPMA)LD50 Dermal Rabbit5,000 mg/kgLD50 Oral Rat5,000 mg/kg

#### **12. ECOLOGICAL INFORMATION**

DO NOT discharge into sewer or waterways.

# 13. DISPOSAL CONSIDERATIONS (See Section 15 for Regulatory Information)

Dissolve or mix the material with a combustible solvent and burn in a chemical incinerator equipped with an afterburner and scrubber. Observed local environmental regulations.

#### 14. TRANSPORT INFORMATION

Not classified as hazardous under transport regulation.

#### **15. REGULATORY INFORMATION**

TOXIC SUBSTANCES CONTROL ACT (TSCA):

All ingredients are on the TSCA inventory or are not required to be list on the TSCA inventory.

#### **16. OTHER INFORMATION**

The above information is believed to be correct but does not purport to be all-inclusive and shall be used only as a guide. Onstatic Technology Co., Ltd. shall not be held liable for any damage resulting from handling or from contacting with the above product.

Prepared by:Oscar YuTitle:QA section managerApproval Date:Aug-06-2013